



FDA33N25

N-Channel UniFET™ MOSFET

250 V, 33 A, 94 mΩ

Features

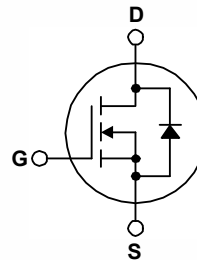
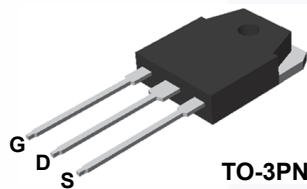
- $R_{DS(on)} = 88 \text{ m}\Omega$ (Typ.) @ $V_{GS} = 10 \text{ V}$, $I_D = 16.5 \text{ A}$
- Low Gate Charge (Typ. 36 nC)
- Low C_{rss} (Typ. 35 pF)
- 100% Avalanche Tested
- RoHS Compliant

Applications

- PDP TV
- Uninterruptible Power Supply
- AC-DC Power Supply

Description

UniFET™ MOSFET is Fairchild Semiconductor's high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.



MOSFET Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted.

| Symbol | Parameter | FDA33N25 | Unit |
|----------------|--|--|------------------|
| V_{DSS} | Drain to Source Voltage | 250 | V |
| V_{GSS} | Gate to Source Voltage | ±30 | V |
| I_D | Drain Current | - Continuous ($T_C = 25^\circ\text{C}$) | 33 |
| | | - Continuous ($T_C = 100^\circ\text{C}$) | 21 |
| I_{DM} | Drain Current | - Pulsed (Note 1) | 132 |
| E_{AS} | Single Pulsed Avalanche Energy | (Note 2) | 918 |
| I_{AR} | Avalanche Current | (Note 1) | 33 |
| E_{AR} | Repetitive Avalanche Energy | (Note 1) | 24.6 |
| dv/dt | Peak Diode Recovery dv/dt | (Note 3) | 4.5 |
| P_D | Power Dissipation | ($T_C = 25^\circ\text{C}$) | 245 |
| | | - Derate Above 25°C | 1.96 |
| T_J, T_{STG} | Operating and Storage Temperature Range | -55 to +150 | $^\circ\text{C}$ |
| T_L | Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds | 300 | $^\circ\text{C}$ |

Thermal Characteristics

| Symbol | Parameter | FDA33N25 | Unit |
|-----------------|---|----------|---------------------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case, Max. | 0.51 | $^\circ\text{C}/\text{W}$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient, Max. | 40 | |

Package Marking and Ordering Information

| Part Number | Top Mark | Package | Packing Method | Reel Size | Tape Width | Quantity |
|-------------|----------|---------|----------------|-----------|------------|----------|
| FDA33N25 | FDA33N25 | TO-3PN | Tube | N/A | N/A | 30 units |

Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted.

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|--------|-----------|-----------------|------|------|------|------|
|--------|-----------|-----------------|------|------|------|------|

Off Characteristics

| | | | | | | |
|--------------------------------|---|---|-----|------|-----------|---------------------------|
| BV_{DSS} | Drain to Source Breakdown Voltage | $I_D = 250 \mu\text{A}$, $V_{GS} = 0 \text{ V}$, $T_J = 25^\circ\text{C}$ | 250 | - | - | V |
| $\Delta BV_{DSS} / \Delta T_J$ | Breakdown Voltage Temperature Coefficient | $I_D = 250 \mu\text{A}$, Referenced to 25°C | - | 0.34 | - | $\text{V}/^\circ\text{C}$ |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{DS} = 250 \text{ V}$, $V_{GS} = 0 \text{ V}$ | - | - | 1 | μA |
| | | $V_{DS} = 200 \text{ V}$, $T_C = 125^\circ\text{C}$ | - | - | 10 | |
| I_{GSS} | Gate to Body Leakage Current | $V_{GS} = \pm 30 \text{ V}$, $V_{DS} = 0 \text{ V}$ | - | - | ± 100 | nA |

On Characteristics

| | | | | | | |
|--------------|--------------------------------------|--|-----|-------|-------|----------|
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{GS} = V_{DS}$, $I_D = 250 \mu\text{A}$ | 3.0 | - | 5.0 | V |
| $R_{DS(on)}$ | Static Drain to Source On Resistance | $V_{GS} = 10 \text{ V}$, $I_D = 16.5 \text{ A}$ | - | 0.088 | 0.094 | Ω |
| g_{FS} | Forward Transconductance | $V_{DS} = 20 \text{ V}$, $I_D = 16.5 \text{ A}$ | - | 24.2 | - | S |

Dynamic Characteristics

| | | | | | | |
|--------------|-------------------------------|--|----------|------|------|----|
| C_{iss} | Input Capacitance | $V_{DS} = 25 \text{ V}$, $V_{GS} = 0 \text{ V}$, $f = 1 \text{ MHz}$ | - | 1655 | 2200 | pF |
| C_{oss} | Output Capacitance | | - | 315 | 420 | pF |
| C_{rss} | Reverse Transfer Capacitance | | - | 35 | 55 | pF |
| $Q_{g(tot)}$ | Total Gate Charge at 10V | $V_{DS} = 200 \text{ V}$, $I_D = 33 \text{ A}$, $V_{GS} = 10 \text{ V}$ | - | 36 | 46.8 | nC |
| Q_{gs} | Gate to Source Gate Charge | | - | 10.8 | - | nC |
| Q_{gd} | Gate to Drain "Miller" Charge | | (Note 4) | - | 16 | - |

Switching Characteristics

| | | | | | | |
|--------------|---------------------|--|----------|-----|-----|-----|
| $t_{d(on)}$ | Turn-On Delay Time | $V_{DD} = 125 \text{ V}$, $I_D = 33 \text{ A}$, $V_{GS} = 10 \text{ V}$, $R_G = 25 \Omega$ | - | 33 | 76 | ns |
| t_r | Turn-On Rise Time | | - | 142 | 293 | ns |
| $t_{d(off)}$ | Turn-Off Delay Time | | - | 77 | 165 | ns |
| t_f | Turn-Off Fall Time | | (Note 4) | - | 68 | 146 |

Drain-Source Diode Characteristics

| | | | | | | |
|----------|--|---|---|-----|-----|---------------|
| I_S | Maximum Continuous Drain to Source Diode Forward Current | - | - | 33 | A | |
| I_{SM} | Maximum Pulsed Drain to Source Diode Forward Current | - | - | 132 | A | |
| V_{SD} | Drain to Source Diode Forward Voltage | $V_{GS} = 0 \text{ V}$, $I_{SD} = 33 \text{ A}$ | - | - | 1.4 | V |
| t_{rr} | Reverse Recovery Time | $V_{GS} = 0 \text{ V}$, $I_{SD} = 33 \text{ A}$, $di_F/dt = 100 \text{ A}/\mu\text{s}$ | - | 256 | - | ns |
| Q_{rr} | Reverse Recovery Charge | | - | 2.3 | - | μC |

Notes:

1. Repetitive rating: pulse-width limited by maximum junction temperature.
2. $L = 1.35 \text{ mH}$, $I_{AS} = 33 \text{ A}$, $V_{DD} = 50 \text{ V}$, $R_G = 25 \Omega$, starting $T_J = 25^\circ\text{C}$.
3. $I_{SD} \leq 33 \text{ A}$, $di/dt \leq 200 \text{ A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$, starting $T_J = 25^\circ\text{C}$.
4. Essentially independent of operating temperature typical Characteristics

Typical Performance Characteristics

Figure 1. On-Region Characteristics

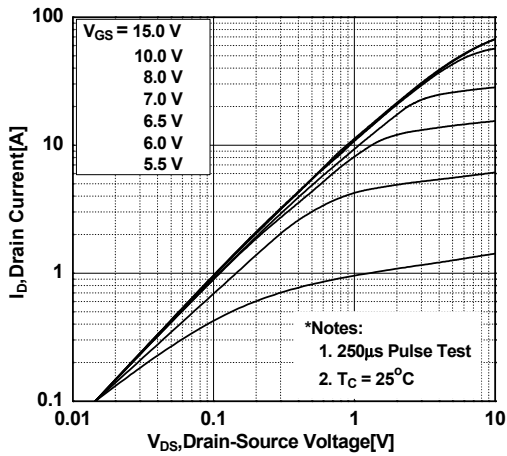


Figure 2. Transfer Characteristics

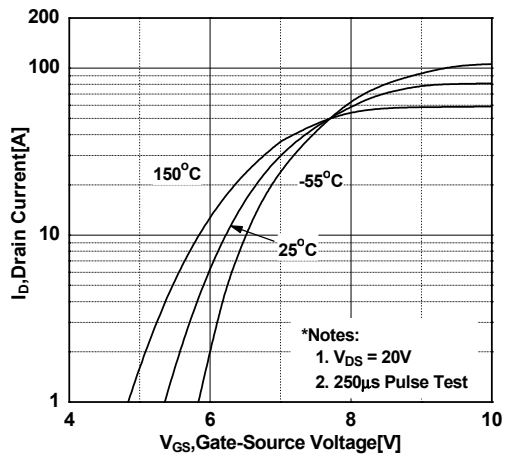


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

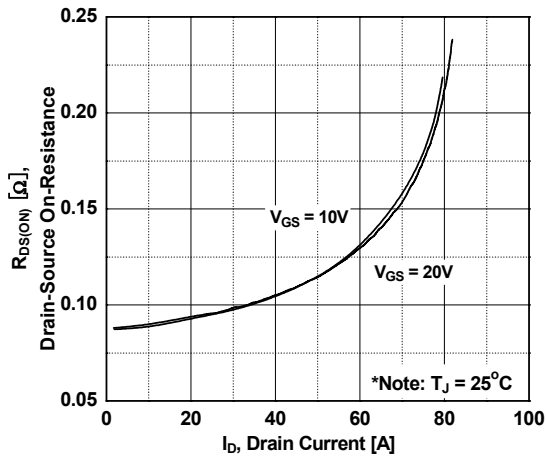


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

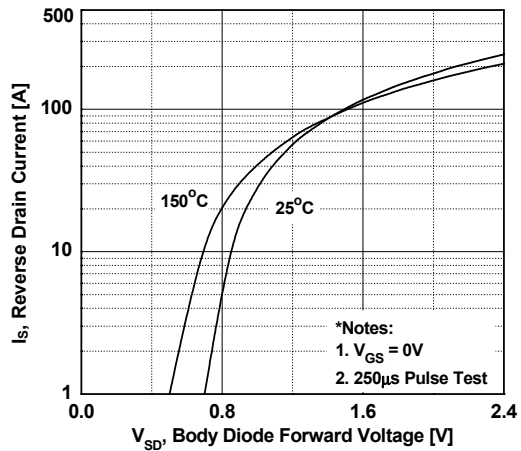


Figure 5. Capacitance Characteristics

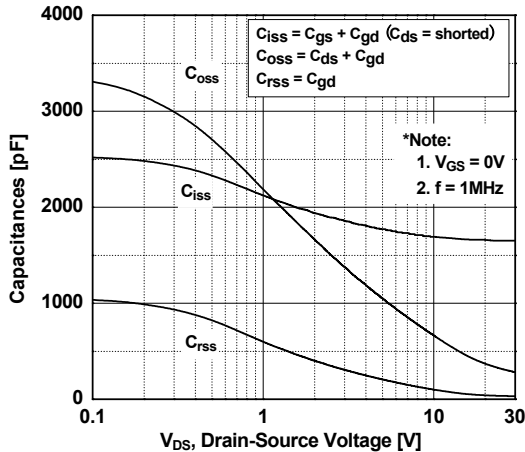
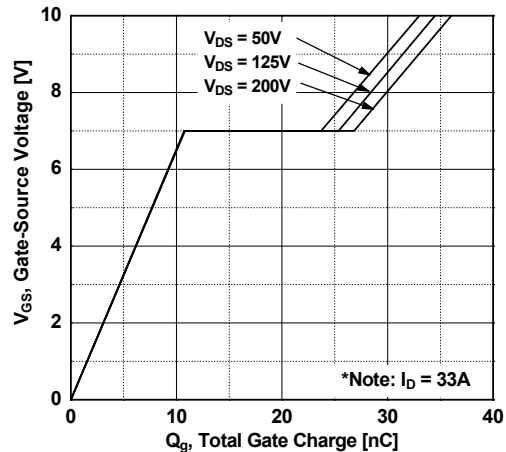


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

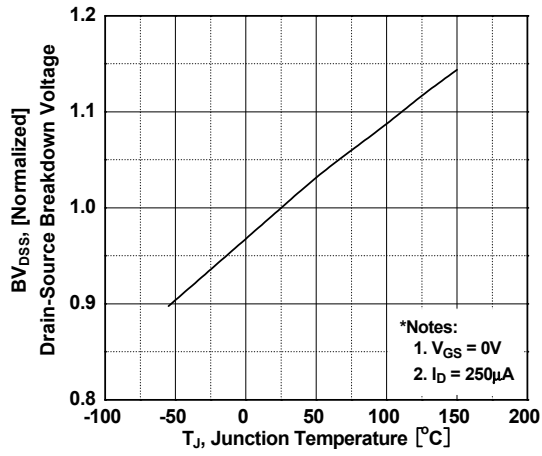


Figure 8. On-Resistance Variation vs. Temperature

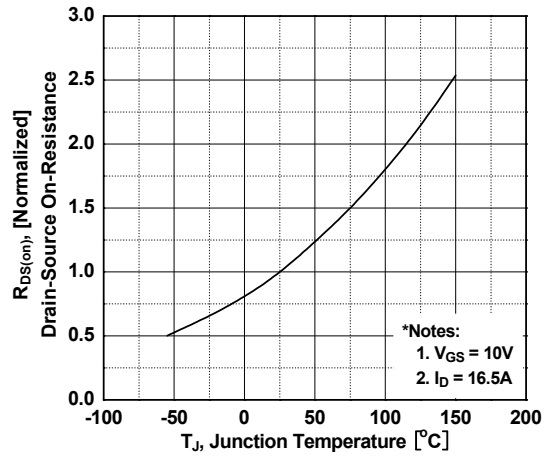


Figure 9. Maximum Safe Operating Area

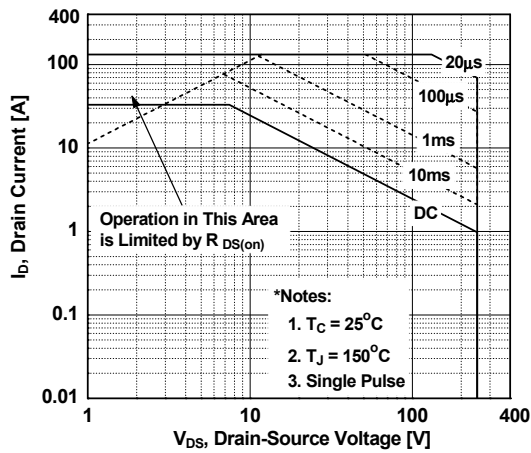


Figure 10. Maximum Drain Current vs. Case Temperature

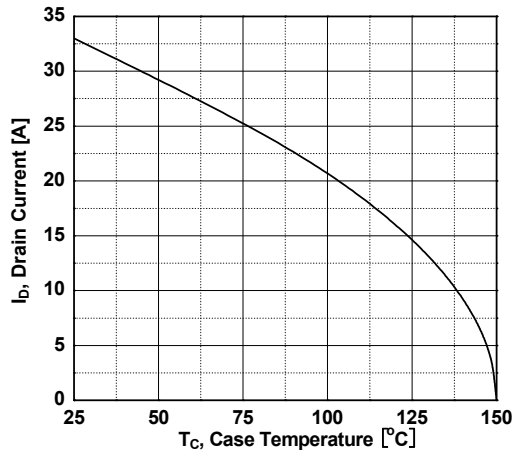


Figure 11. Transient Thermal Response Curve

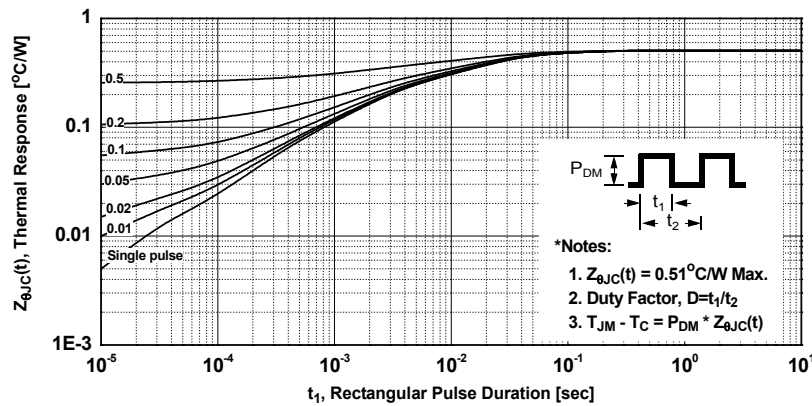




Figure 12. Gate Charge Test Circuit & Waveform

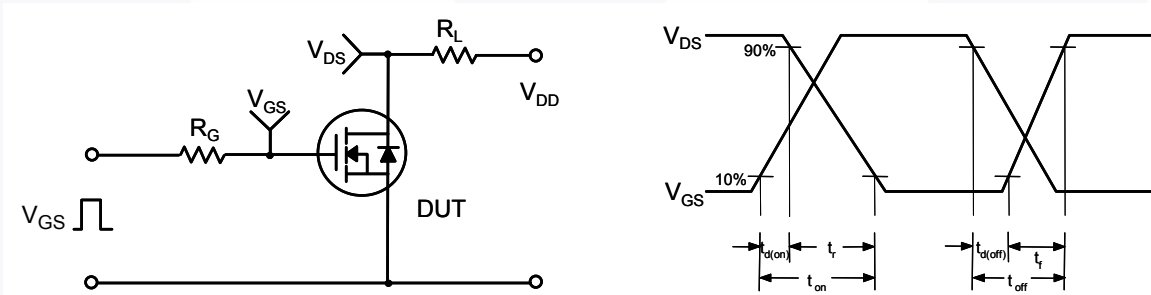


Figure 13. Resistive Switching Test Circuit & Waveforms

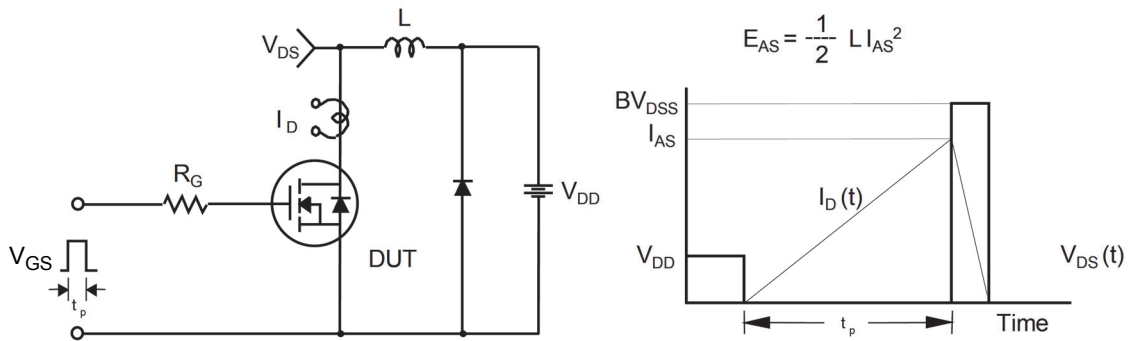
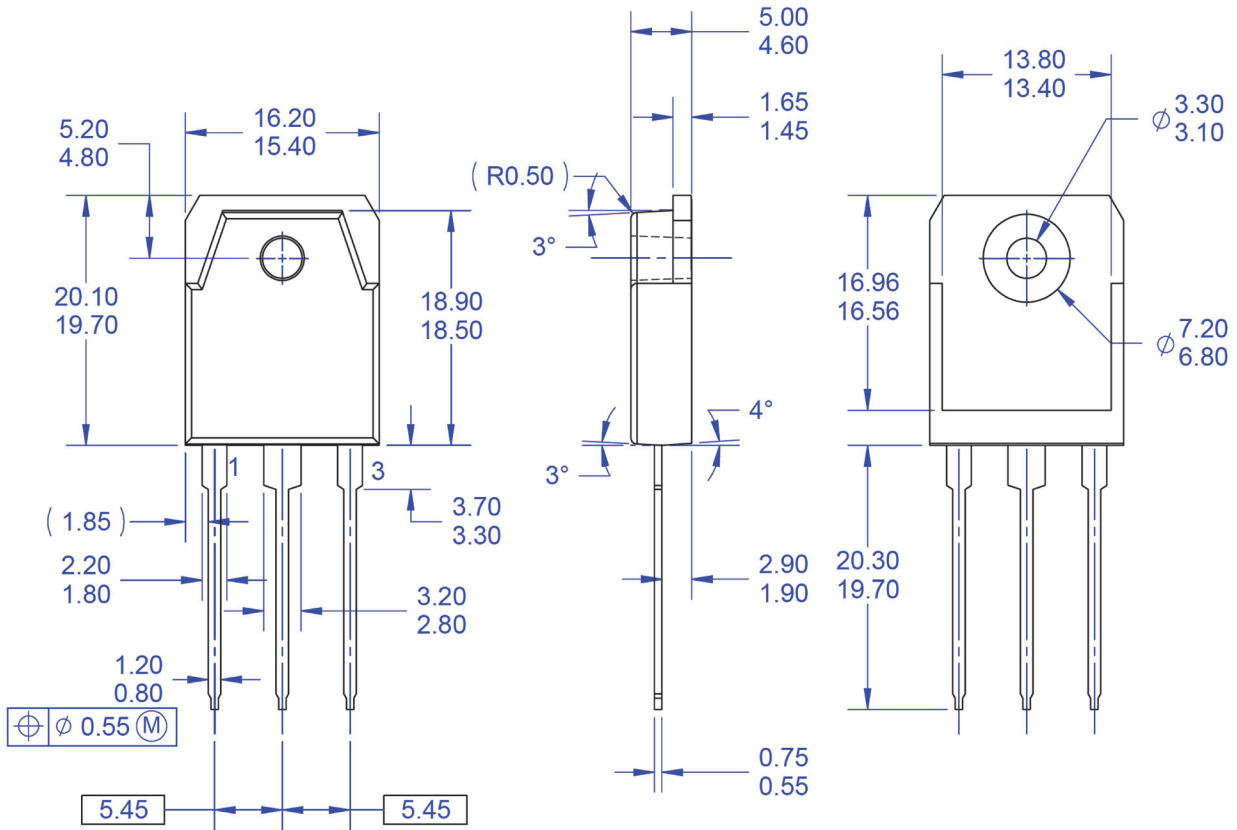


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

Mechanical Dimensions



NOTES: UNLESS OTHERWISE SPECIFIED

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- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSION AND TOLERANCING PER ASME14.5-2009.
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- E) DRAWING FILE NAME: TO3PN03AREV1.
- F) FAIRCHILD SEMICONDUCTOR.

Figure 16. TO3PN, 3-Lead, Plastic, EIAJ SC-65

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